

CHINA DEVELOPMENT BANK BENCHMARK BOND ISSUANCE PROGRAMME TENDER ANNOUNCEMENT

20 September 2023

Issue Number 092302002 Tender Type Reopening **Tender Date** 21 September 2023 Tender Time 9:30 am to 10:30 am Offering Amount Renminbi 1.5 Billion Fixed Interest Type 2.71% Coupon Rate **Interest Payment Frequency** Annually **Interest Payment Date** 10 July Original Tenor Seven Years 10 July 2030 Maturity Date Issue and Settlement Date 22 September 2023 Dated Date(Value Date) 10 July 2023 25 September 2023 Listing Date **Clearing House** Shanghai Clearing House Market China's Inter-bank Bond Market(CIBM) Exempted for issuance in CIBM Rating

For offshore issuance, China's Quasi-sovereign ratings, i.e. Moody's: A1(Stable), S&P: A+(Stable)

CDB's bond yield curve available at http://www.cdb.com.cn.

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